

12 GHz Silicon NPN Planar RF Transistor

Features

- Low power applications
- Very low noise figure
- High transition frequency $f_T = 12$ GHz
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



Applications

For low noise and small signal low power amplifiers. This transistor has superior noise figure and associated gain performance at UHF, VHF and microwave frequencies.

Mechanical Data

Typ: TSDF1205

Case: SOT-143 Plastic case

Weight: approx. 8.0 mg

Pinning: 1 = Collector, 2 = Emitter,

3 = Base, 4 = Emitter

Typ: TSDF1205R

Case: SOT-143R Plastic case

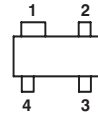
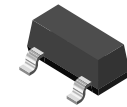
Weight: approx. 8.0 mg

Pinning: 1 = Collector, 2 = Emitter,

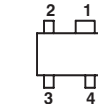
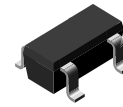
3 = Base, 4 = Emitter



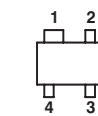
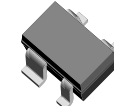
SOT-143



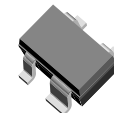
SOT-143R



SOT-343



SOT-343R



Electrostatic sensitive device.
Observe precautions for handling.

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Typ: TSDF1205W

Case: SOT-343 Plastic case

Weight: approx. 6.0 mg

Pinning: 1 = Collector, 2 = Emitter,

3 = Base, 4 = Emitter

Typ: TSDF1205RW

Case: SOT-343R Plastic case

Weight: approx. 8.0 mg

Pinning: 1 = Collector, 2 = Emitter,

3 = Base, 4 = Emitter

Parts Table

Part	Marking	Package
TSDF1205	F05	SOT-143
TSDF1205R	05F	SOT-143R
TSDF1205RW	WF0	SOT-343R
TSDF1205W	W0F	SOT-343

Absolute Maximum Ratings

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Collector-base voltage		V_{CBO}	9	V
Collector-emitter voltage		V_{CEO}	4	V
Emitter-base voltage		V_{EBO}	2	V
Collector current		I_C	12	mA
Total power dissipation	$T_{amb} \leq 132\text{ }^{\circ}\text{C}$	P_{tot}	40	mW
Junction temperature		T_j	150	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	- 65 to + 150	$^{\circ}\text{C}$

Maximum Thermal Resistance

Parameter	Test condition	Symbol	Value	Unit
Junction ambient	1)	R_{thJA}	450	K/W

1) on glass fibre printed board (25 x 20 x 1.5) mm³ plated with 35 μm Cu

Electrical DC Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Collector-emitter cut-off current	$V_{CE} = 12\text{ V}, V_{BE} = 0$	I_{CES}			100	μA
Collector-base cut-off current	$V_{CB} = 10\text{ V}, I_E = 0$	I_{CBO}			100	nA
Emitter-base cut-off current	$V_{EB} = 1\text{ V}, I_C = 0$	I_{EBO}			2	μA
Collector-emitter breakdown voltage	$I_C = 1\text{ mA}, I_B = 0$	$V_{(BR)CEO}$	4			V
Collector-emitter saturation voltage	$I_C = 5\text{ mA}, I_B = 0.5\text{ mA}$	V_{CEsat}		0.1	0.5	V
DC forward current transfer ratio	$V_{CE} = 2\text{ V}, I_C = 2\text{ mA}$	h_{FE}	50	120	250	

Electrical AC Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Transition frequency	$V_{CE} = 2\text{ V}$, $I_C = 5\text{ mA}$, $f = 1\text{ GHz}$	f_T		12		GHz
Collector-base capacitance	$V_{CB} = 1\text{ V}$, $f = 1\text{ MHz}$	C_{cb}		0.2		pF
Collector-emitter capacitance	$V_{CE} = 1\text{ V}$, $f = 1\text{ MHz}$	C_{ce}		0.35		pF
Emitter-base capacitance	$V_{EB} = 0.5\text{ V}$, $f = 1\text{ MHz}$	C_{eb}		0.15		pF
Noise figure	$V_{CE} = 2\text{ V}$, $I_C = 2\text{ mA}$, $Z_S = Z_{Sopt}$, $Z_L = 50\text{ }\Omega$, $f = 2\text{ GHz}$	F		1.3		dB
Power gain	$V_{CE} = 2\text{ V}$, $I_C = 2\text{ mA}$, $f = 2\text{ GHz}$ (@ F_{opt})	G_{pe}		13		dB
	$V_{CE} = 2\text{ V}$, $I_C = 5\text{ mA}$, $Z_S = Z_{Sopt}$, $Z_L = 50\text{ }\Omega$, $f = 2\text{ GHz}$	G_{pe}		11.5		dB
Transducer gain	$V_{CE} = 2\text{ V}$, $I_C = 5\text{ mA}$, $Z_0 = 50\text{ }\Omega$, $f = 2\text{ GHz}$	$ S_{21e} ^2$		12.5		dB

Typical Characteristics ($T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

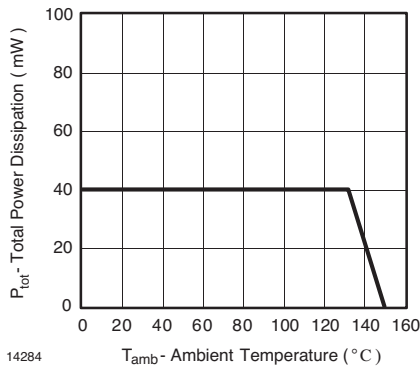


Figure 1. Total Power Dissipation vs. Ambient Temperature

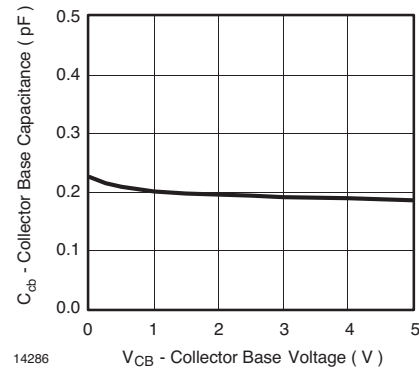


Figure 3. Collector Base Capacitance vs. Collector Base Voltage

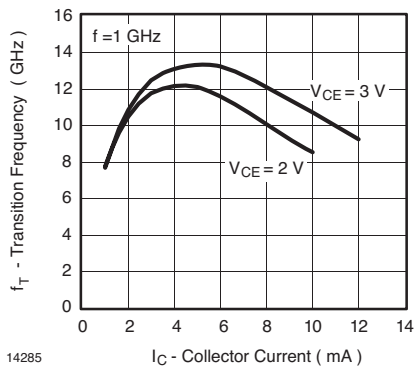


Figure 2. Transition Frequency vs. Collector Current

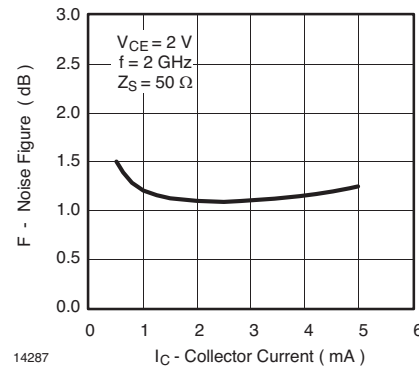
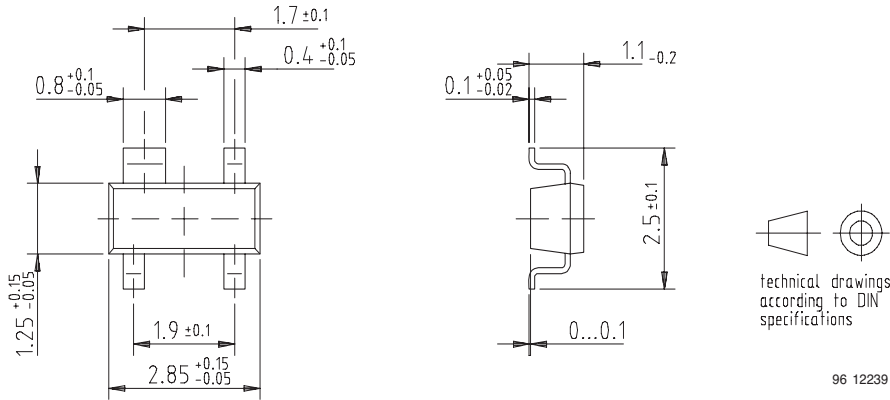
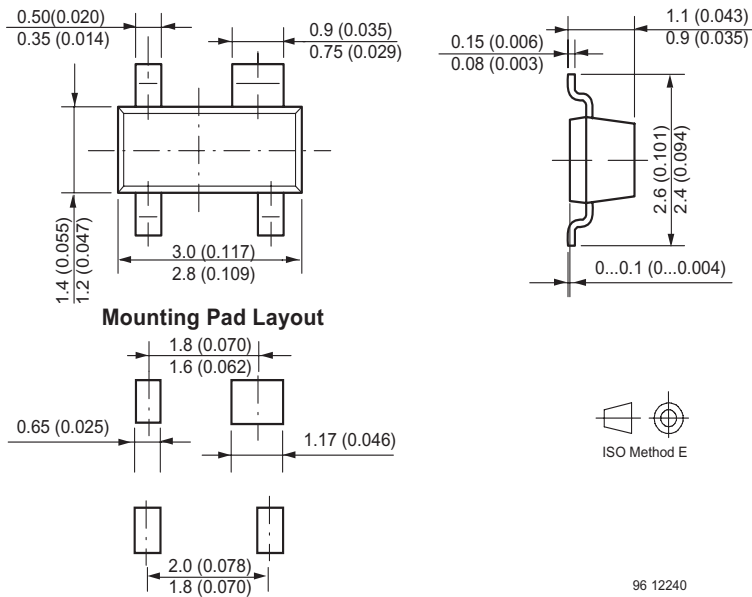


Figure 4. Noise Figure vs. Collector Current

Package Dimensions in mm

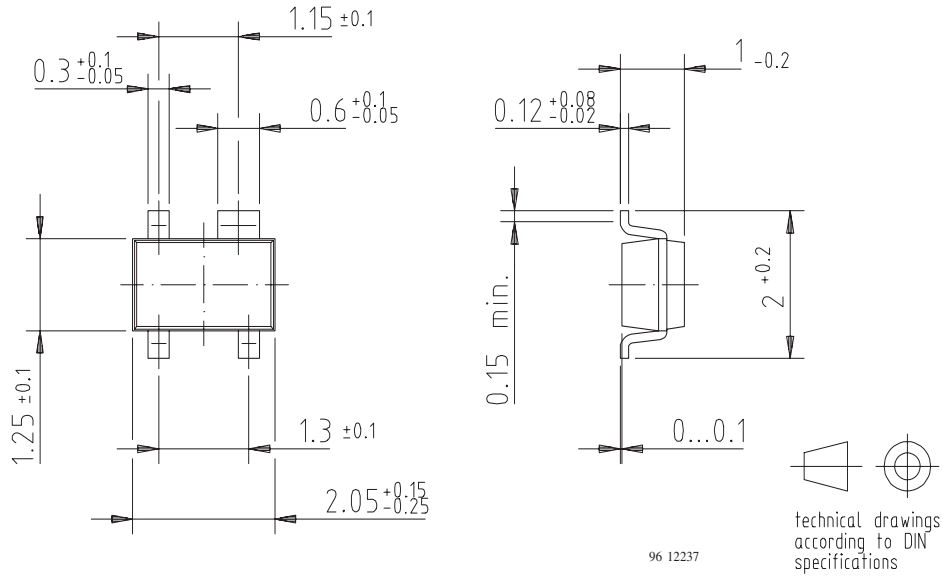


Package Dimensions in mm

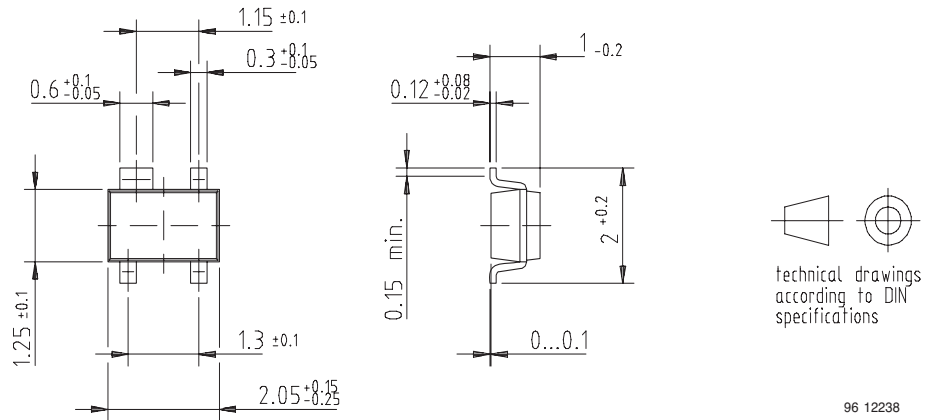




Package Dimensions in mm



Package Dimensions in mm





Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

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